

Customer Information Notification

Issue Date: 14-Mar-2019 Effective Date: 15-Mar-2019

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2019010291



coverage

Change Category

[] Wafer Fab Process [] Assembly [] Product Marking []Test [] Design **Process** Location [] Wafer Fab Materials [] Assembly [] Mechanical Specification[]Test [] Errata Materials **Process** [] Wafer Fab Location [] Assembly [] [] Test [X] Electrical Location Packing/Shipping/Labeling Equipment spec./Test

[] Firmware [] Other

MC9S08PA4
Datasheet Update to
Revision 9

Description

NXP Semiconductors announces a data sheet update for the MC9S08PA4 to revision 9. The revision history included in the updated document provides a detailed description of the changes. Changes are summarized below.

- 1. Updated the S3IDD Typical values in Supply current characteristics.
- 2. Added the package drawing information of 20-pin TSSOP.

The MC9S08PA4 data sheet revision 9 is attached to this notice, and can be found at: NXP PA4 datasheet link: https://www.nxp.com/s08p

Reason

The data sheet has been updated to correct errors and provide additional technical clarification on some device features.

Identification of Affected Products

Product identification does not change

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Data Sheet Revision

A new datasheet will be issued

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

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NXP Quality Management Team.

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Affected Part Numbers

MC9S08PA4AVTGR

MC9S08PA4AVTG

MC9S08PA4VTGR

MC9S08PA4VTG

MC9S08PA4AVTJ

MC9S08PA4MTGR

MC9S08PA4MTG

MC9S08PA4AVDC

MC9S08PA4AVSC

MC9S08PA4AVWJ